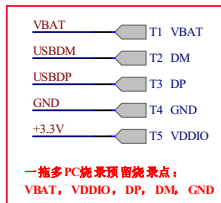
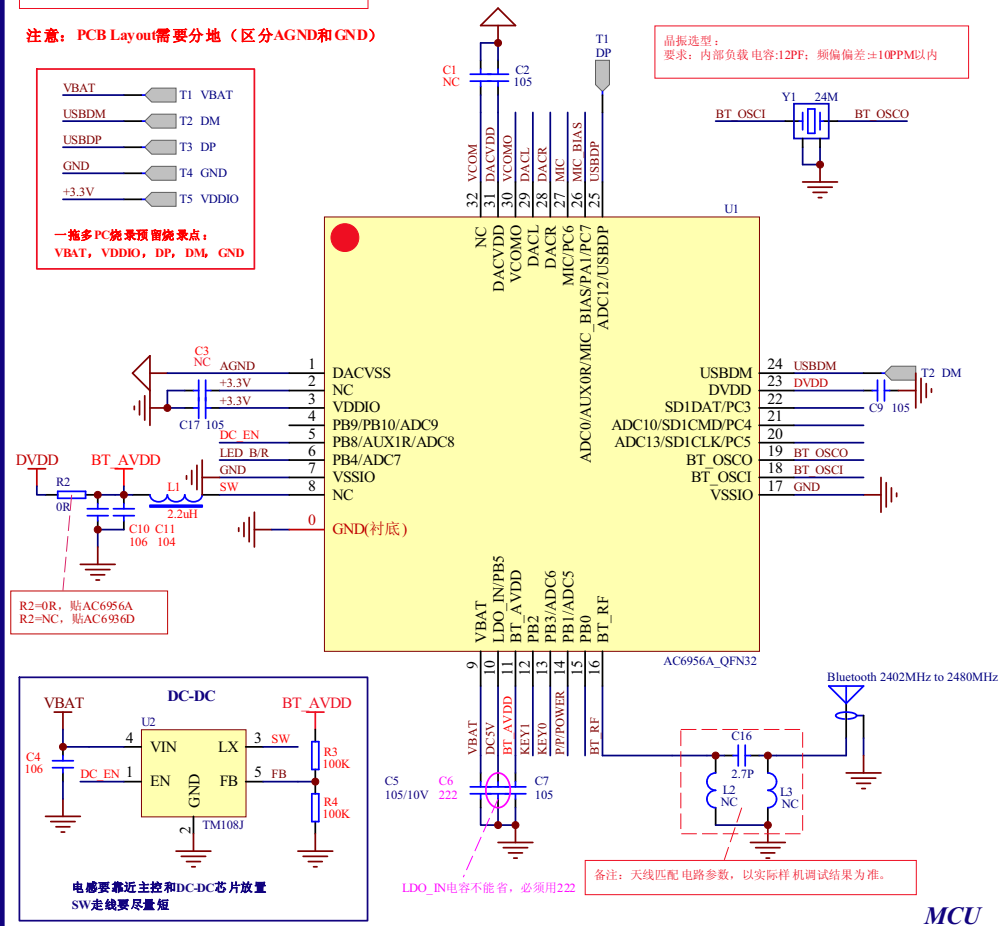


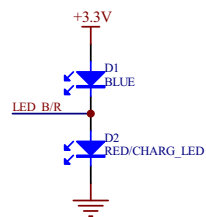
注意：PCB Layout需要分地（区分AGND和GND）



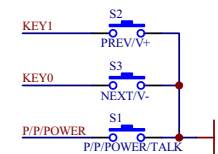
晶振选型：
要求：内部负载电容:12PF；频偏偏差±10PPM以内



MCU



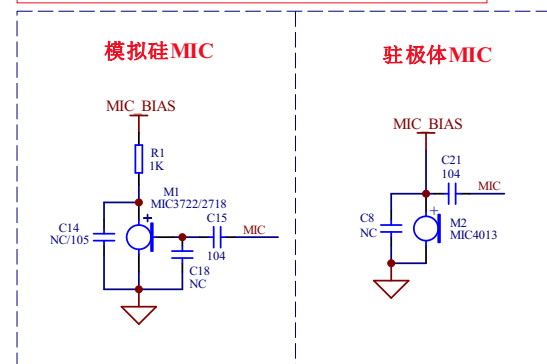
LED



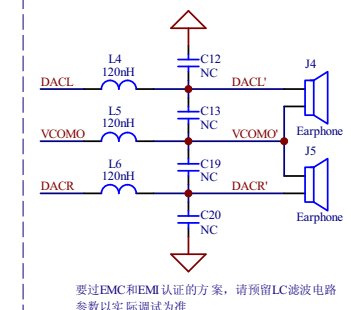
KEY

备注:

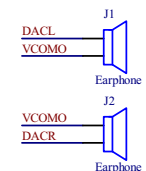
1、硅麦：一致性好，灵敏度高，抗干扰能力强，通话效果好



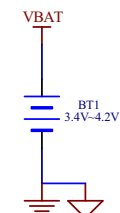
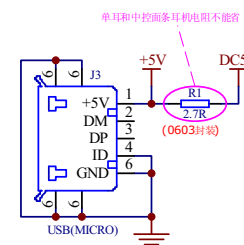
MIC电路处的滤波电容位置需预留



要过EMC和EMI 认证的方案, 请预留LC滤波电路参数以实际调试为准



Mic、Earphone



备注:
1、GND、AGND在电池地 处短接在一起!
2、电池必须使用带保护板的电池

POWER